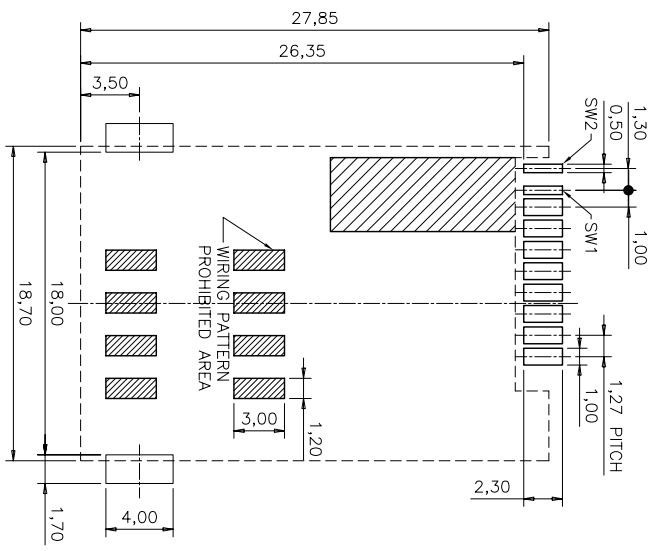
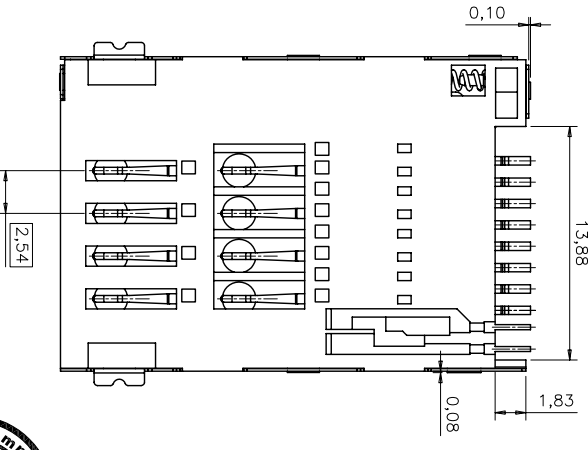
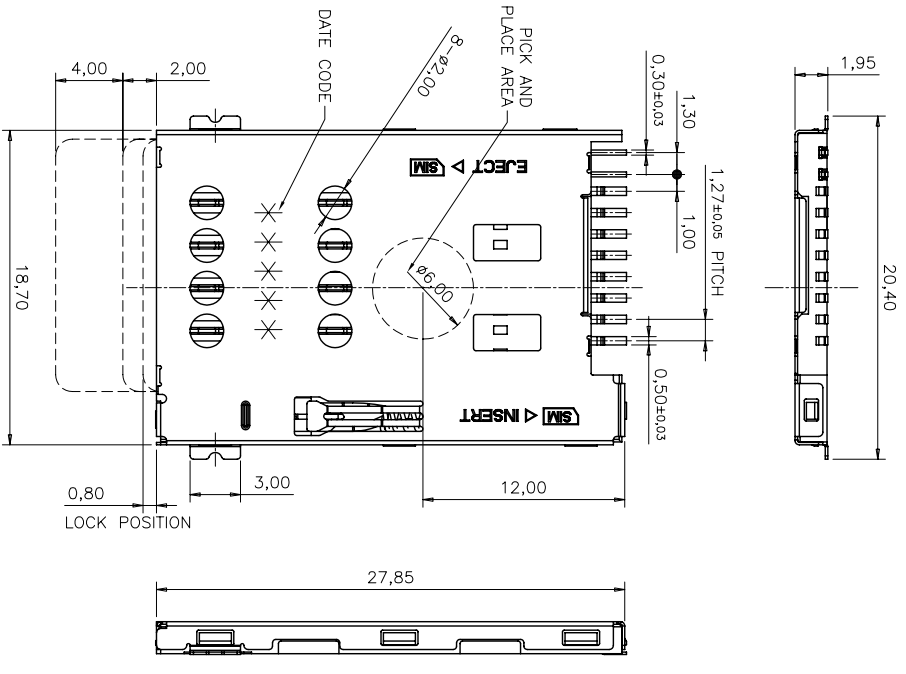
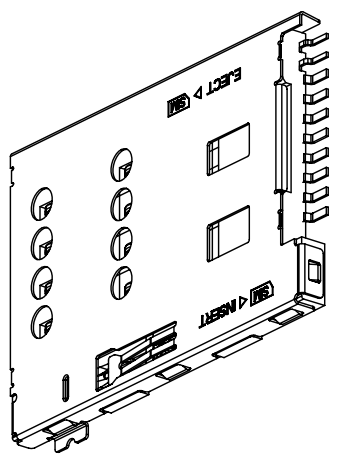


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# CUSTOMER DRAWING



RECOMMENDED PCB LAYOUT (X:XX±0.05)  
(TOP VIEW)

- NOTE:
1. MATERIAL: HIGH TEMP. THERMOPLASTIC, UL94V-0; COLOR: BLACK; INSULATOR: ALLOY COPPER, THICKNESS = 0.15MM; CONTACT: ALLOY COPPER THICKNESS = 0.10MM; SWITCH: STAINLESS STEEL, THICKNESS = 0.15MM
  2. PLATING: SHELL: STAINLESS STEEL, THICKNESS = 0.15MM; CONTACT: 50u" MIN. NICKEL PLATED OVERALL, SEE ORDER P/N FOR MATING AREA, 120u" MIN. Tm ON SOLDER TAILS; SHELL: 50u" NICKEL PLATED OVERALL; GOLD FLASH ON SOLDER TAILS;
  3. THE COMPLIANCE IS 0.10MM MAX FOR ALL SOLDER TAILS;
  4. MATERIAL SHOULD BE FILLED AMPHENOL SPEC# SSM001.



ORDER P/N  
CAD-08-PA-001-X

Gold Plating  
1. 0.76um gold Plating  
2. 0.38um gold Plating  
3. Gold Flash

REVISIONS				
SW	ECN	DESCRIPTION	DATE	APPROVED
C	HK4434	RELEASE TO CUSTOMER	05/04/07	IP
D	HK****	RELEASE TO CUSTOMER	06/25/07	IP

UNLESS OTHERWISE SPECIFIED TOLERANCES		APPROVAL		DATE	
U.S.	METRIC	DRAWN	CHECKED	DR	DATE
±0.20	±0.13	Johnson, Yoo	DB, Gao	08/25/07	08/25/07
±0.13	±0.13				

DIMENSIONS		ANGLE OF PROJECTION		TITLE	
U.S.	METRIC	U.S.	METRIC	SIZE	SCALE
1"	1"	1"	1"	A3	NONE
				C CAD-08-PA-001-X	
				SCALE	SHEET 1 OF 1

Amphenol  
BRIN PUSH PUSH SIM CARD READER  
(WITH SWITCH)